DECLARATION AND POWER OF A ITORNEY

As a below named inve	entor, I hereby declare that:	
My residence, post of	ce and citizenship are as stated below next to my name,	
names are listed hel	mal, first and sole inventor (if only one name is listed below) or low) of the subject matter claimed and for which a pay SYSTEM AND METHOD ON A FORWAR	tant la compete ou the investor aller
	[] was filed on as Application Serial amended on (if applicable	No. snd was
I hereby state that 1 h amended by any amen	ave reviewed and understand the contents of the above ident intent referred to above.	fied specification, including the claims, as
Code of Federal Regul	•	
America, listed below	priority benefits under 35 U.S.C. 119(a)-(d) or 365(b) of any fif any PCT international application which designated at least and have also identified below, by checking the box, any CT international application having a filing date before that of the	one country other man the United States of foreign application for patent or inventor's
Prior Foreign Applies Number	country	Foreign Filing Date Month/Day/Year
P2000-73665	KOREA	December 06, 2000
11 8 44.00 1		
	fit under 35 U.S.C.119(e) of any United States provisional appli Filing Date(Month/Day/Year)	ication(s) listed below.
designating the United not disclosed in the pri 112, I acknowledge th	fit under 35, U. S. C. 120 of any United States application(s), or States of America, listed below and, intofar as the subject matter United States or PCT international application in the manner is duty to disclose information which is material to patentability filing date of the prior application and the national or PCT international date of the prior application and the national or PCT international date of the prior application and the national or PCT international date of the prior application and the national or PCT international date of the prior application and the national or PCT international date of the prior application and the national or PCT international date of the prior application and the national date of the national	er of each of the claims of this application is provided by the first paragraph of 35 U.S. C y as defined in 37 CFR 1.56 which becam
Prior U.S. Application or PCT Parent Numb		Parent Patent Number (if applicable)
belief are believed to l like so made are punis	all statements made herein of my own knowledge are true and the true; and further that these statements were made with the knowledge by fine or imprisonment, or both, under Section 1001 of the many jeopardize the validity of the application or any paten	owledge that willful false statements and the Title 18 of the United States Code and that



I hereby appoint the following attorney(s) and/or agent(s):Daniel Y.J. Kim, Registration No. 36,186 and Mark L. Fleshner, Registration No. 34,596; Carl R. Wesolowski, Registration No. 40,372, John C. Eisenhart, Registration No. 38,128, Rene A. Vasquez, Registration No. 38,647; Stuart I. Smith, Registration No. 42,159; Carol L. Druzbick, Registration No. 40,287; Anthony H.Nourse, Registration No. 46,121; and Margaret A. Burke, Registration No. 34,474, all of

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with full power of sub-	elitation and revocation, with, and all future corre	to prosecute this application and to trans spondence should be addressed to them.	act all business in the Par	ent and Trademark
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